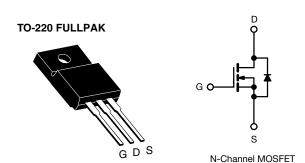
Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	1.5		
Q _g max. (nC)	20			
Q _{gs} (nC)	3			
Q _{gd} (nC)	5			
Configuration	Sing	le		

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qg
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF5N50D-E3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	500	
Gate-Source Voltage			.,	± 30	V
Gate-Source Voltage AC (f > 1 Hz)			V_{GS}	30	
Continuous Drain Correct /T 150 °C) 6	V at 10 V	T _C = 25 °C		5.3	
Continuous Drain Current (T _J = 150 °C) ^e	V _{GS} at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	l _D	3.4	Α
Pulsed Drain Current ^a			I _{DM}	10	
Linear Derating Factor				0.24	W/°C
Single Pulse Avalanche Energy b			E _{AS}	23	mJ
Maximum Power Dissipation			P_{D}	28.8	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	24	\//no	
Reverse Diode dV/dt ^d			0.28	V/ns	
Soldering Recommendations (Peak temperature) c For 10 s			300	°C	
Mounting Torque M3 screw			0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.3 mH, $R_q = 25$ Ω , $I_{AS} = 5$ Å.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.
- e. Limited by maximum junction temperature.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	65	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	4.1	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zava Cata Valtaga Dvaia Cuwant		V _{DS} =	= 500 V, V _{GS} = 0 V	-		1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.5 A	-	1.2	1.5	Ω
Forward Transconductance a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	325	-	
Output Capacitance	C _{oss}]	V _{DS} = 100 V,	-	34	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	6	-	1
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	31	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	$v_{DS} = 0$	v to 400 v, v _{GS} = 0 v	-	41	-	
Total Gate Charge	Qg			-	10	20	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 2.5 \text{ A}, V_{DS} = 400 \text{ V}$	-	3	-	nC
Gate-Drain Charge	Q _{gd}			-	5	-	
Turn-On Delay Time	t _{d(on)}			-	12	24	
Rise Time	t _r	V _{DD} =	400 V, I _D = 2.5 A	-	11	22	, no
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega, V_{GS} = 10 V$		-	14	28	ns
Fall Time	t _f			-	11	22	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	5	^
Pulsed Diode Forward Current	I _{SM}	integral revers P - N junction		-	-	20	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 4 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	320	-	ns
Reverse Recovery Charge	Q _{rr}		5 °C, I _F = I _S = 2.5 A, 100 A/µs, V _B = 20 V	-	1.2	-	μC
Reverse Recovery Current	I _{RRM}	u/ui =	100 AV 40, VR = 20 V	-	8	-	Α

Note

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

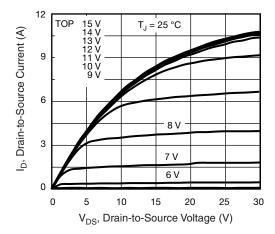


Fig. 1 - Typical Output Characteristics

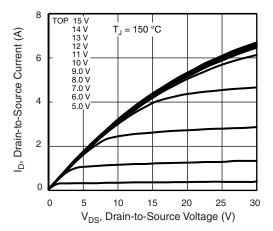


Fig. 2 - Typical Output Characteristics

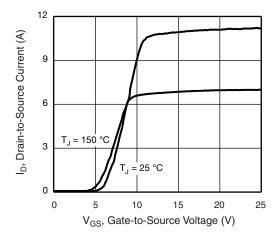


Fig. 3 - Typical Transfer Characteristics

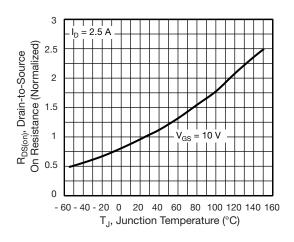


Fig. 4 - Normalized On-Resistance vs. Temperature

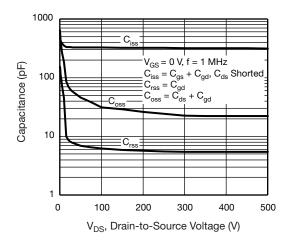


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

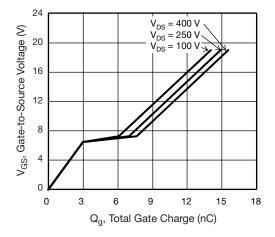


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



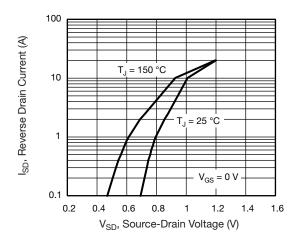


Fig. 7 - Typical Source-Drain Diode Forward Voltage

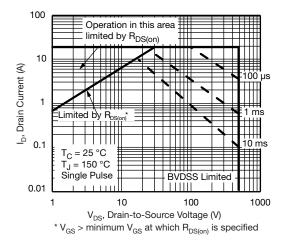


Fig. 8 - Maximum Safe Operating Area

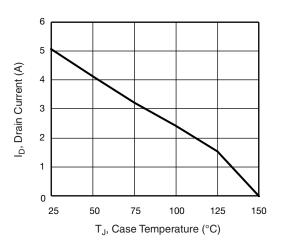


Fig. 9 - Maximum Drain Current vs. Case Temperature

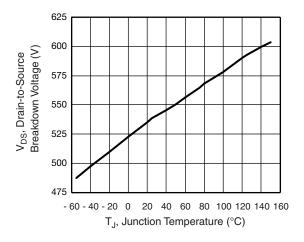


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

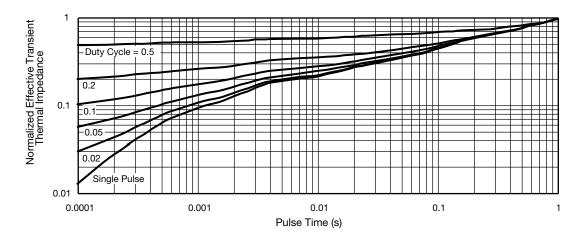


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

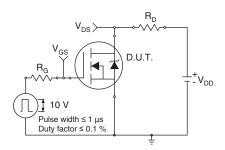


Fig. 12 - Switching Time Test Circuit

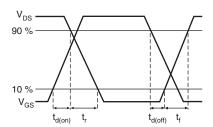


Fig. 13 - Switching Time Waveforms

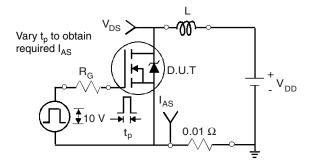


Fig. 14 - Unclamped Inductive Test Circuit

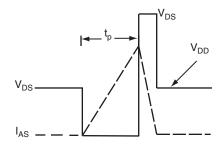


Fig. 15 - Unclamped Inductive Waveforms

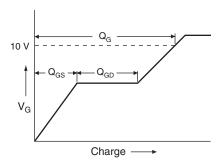


Fig. 16 - Basic Gate Charge Waveform

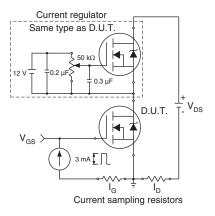
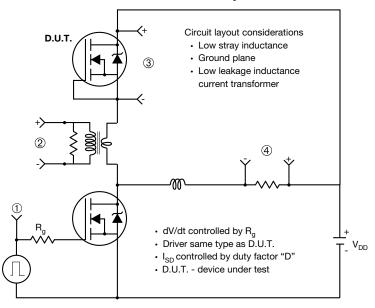


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



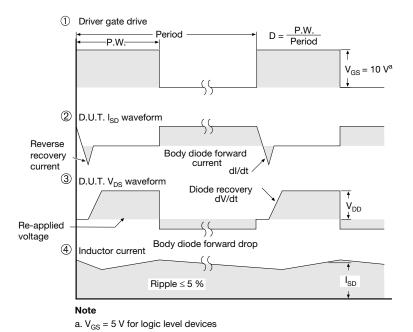


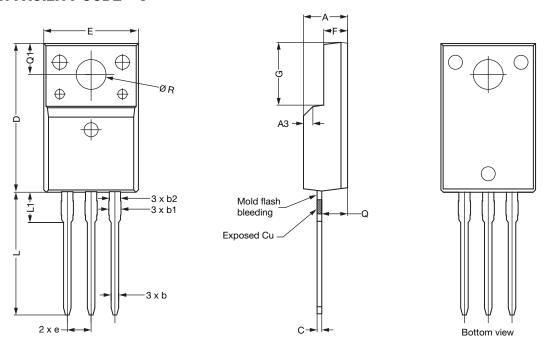
Fig. 18 - For N-Channel

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Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



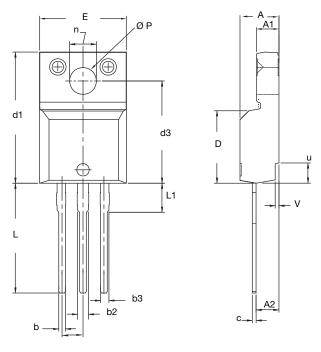
		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



	MILL	IETERS	INCI	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
Е	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100 BSC	
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØΡ	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

ECN: E19-0180-Rev. D, 08-Apr-2019 DWG: 5972

Notes

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